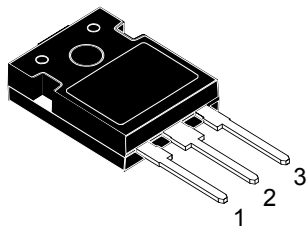
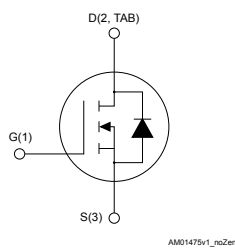


Silicon carbide Power MOSFET 1700 V, 1.0 Ω typ., 7 A in an HiP247 package



HiP247



Features

Order code	V_{DS}	$R_{DS(on)}$ max.	I_D
SCT1000N170	1700 V	1.3 Ω	7 A

- High speed switching performance
- Very fast and robust intrinsic body diode
- Low capacitances
- Very high operating junction temperature capability ($T_J = 200\text{ }^{\circ}\text{C}$)

Applications

- Auxiliary power supply for server
- Switch mode power supply

Description

This silicon carbide Power MOSFET is produced exploiting the advanced, innovative properties of wide bandgap materials. This results in unsurpassed on-resistance per unit area and very good switching performance almost independent of temperature. The outstanding thermal properties of the SiC material, combined with the device's housing in the proprietary HiP247 package, allows designers to use an industry standard outline with significantly improved thermal capability. These features render the device perfectly suitable for high-efficiency and high power density applications.

Product status link

[SCT1000N170](#)

Product summary

Order code	SCT1000N170
Marking	SCT1000N170
Package	HiP247
Packing	Tube

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{DS}	Drain-source voltage	1700	V
V_{GS}	Gate-source voltage	-10 to 22	V
I_D	Drain current (continuous) at $T_C = 25\text{ °C}$	7	A
	Drain current (continuous) at $T_C = 100\text{ °C}$	5	
$I_{DM}^{(1)}$	Drain current (pulsed)	20	A
P_{TOT}	Total power dissipation at $T_C = 25\text{ °C}$	96	W
T_{stg}	Storage temperature range	-55 to 200	°C
T_J	Operating junction temperature range		°C

1. Pulse width is limited by safe operating area.

Table 2. Thermal data

Symbol	Parameter	Value	Unit
R_{thJC}	Thermal resistance junction-to-case	1.83	°C/W
R_{thJA}	Thermal resistance junction-to-ambient	40	°C/W

2 Electrical characteristics

$T_C = 25\text{ °C}$ unless otherwise specified.

Table 3. On/off states

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0\text{ V}$, $I_D = 1\text{ mA}$	1700			V
I_{DSS}	Zero gate voltage drain current	$V_{GS} = 0\text{ V}$, $V_{DS} = 1700\text{ V}$			10	μA
I_{GSS}	Gate-body leakage current	$V_{DS} = 0\text{ V}$, $V_{GS} = -10\text{ to }22\text{ V}$			± 100	nA
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 1\text{ mA}$	2.1	3.5		V
$R_{DS(on)}$	Static drain-source on-resistance	$V_{GS} = 20\text{ V}$, $I_D = 3\text{ A}$		1.0	1.3	Ω
		$V_{GS} = 20\text{ V}$, $I_D = 3\text{ A}$, $T_J = 150\text{ °C}$		1.27		
		$V_{GS} = 20\text{ V}$, $I_D = 3\text{ A}$, $T_J = 200\text{ °C}$		1.66		

Table 4. Dynamic

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{iss}	Input capacitance	$V_{DS} = 1000\text{ V}$, $f = 1\text{ MHz}$, $V_{GS} = 0\text{ V}$	-	133	-	pF
C_{oss}	Output capacitance		-	11.3	-	pF
C_{rss}	Reverse transfer capacitance		-	3.4	-	pF
R_g	Gate input resistance	$f = 1\text{ MHz}$, $I_D = 0\text{ A}$	-	9.6	-	Ω
Q_g	Total gate charge	$V_{DS} = 1000\text{ V}$, $I_D = 2\text{ A}$, $V_{GS} = -5\text{ V to }20\text{ V}$	-	13.3	-	nC
Q_{gs}	Gate-source charge		-	8.7	-	nC
Q_{gd}	Gate-drain charge		-	1.7	-	nC

Table 5. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
E_{on}	Turn-on switching energy	$V_{DD} = 1000\text{ V}$, $I_D = 2\text{ A}$	-	50	-	μJ
E_{off}	Turn-off switching energy	$R_g = 10\text{ }\Omega$, $V_{GS} = -5\text{ V to }20\text{ V}$	-	17	-	μJ
E_{on}	Turn-on switching energy	$V_{DD} = 1000\text{ V}$, $I_D = 2\text{ A}$, $R_g = 10\text{ }\Omega$,	-	65	-	μJ
E_{off}	Turn-off switching energy	$V_{GS} = -5\text{ V to }20\text{ V}$, $T_J = 200\text{ °C}$	-	18	-	μJ

Table 6. Reverse SiC diode characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V_{SD}	Diode forward voltage	$I_F = 3\text{ A}$, $V_{GS} = 0\text{ V}$	-	4.5	-	V
t_{rr}	Reverse recovery time	$I_{SD} = 2\text{ A}$, $V_{GS} = 0\text{ V}$, $di/dt = 1000\text{ A}/\mu\text{s}$, $V_{DD} = 1000\text{ V}$	-	22	-	ns
Q_{rr}	Reverse recovery charge		-	92	-	nC
I_{RRM}	Reverse recovery current		-	7	-	A

2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

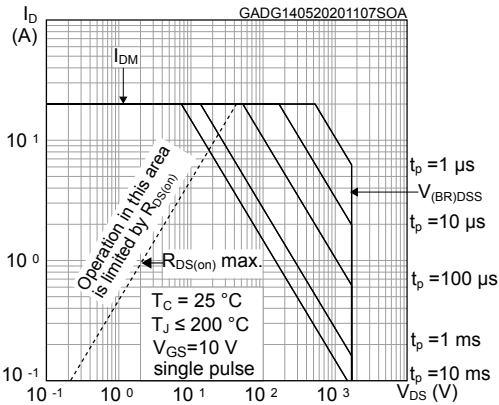


Figure 2. Maximum transient thermal impedance

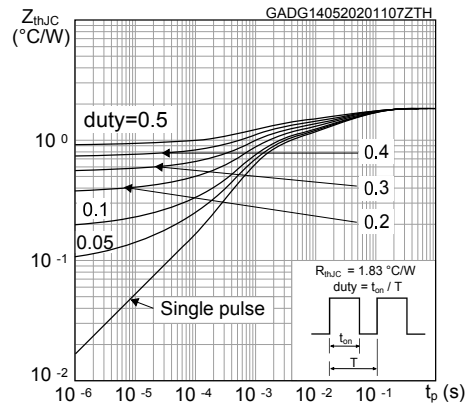


Figure 3. Typical output characteristics ($T_J = 25\text{ °C}$)

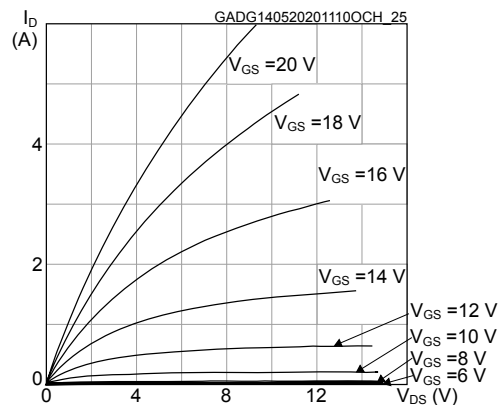


Figure 4. Typical output characteristics ($T_J = 200\text{ °C}$)

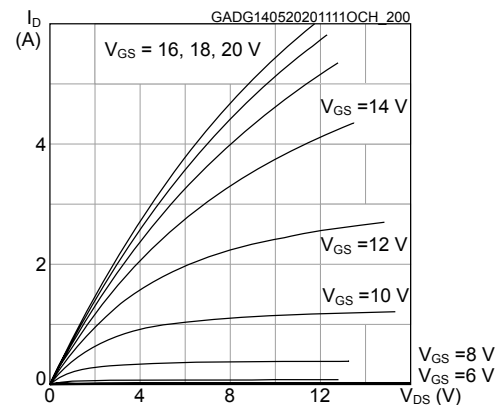


Figure 5. Typical transfer characteristics

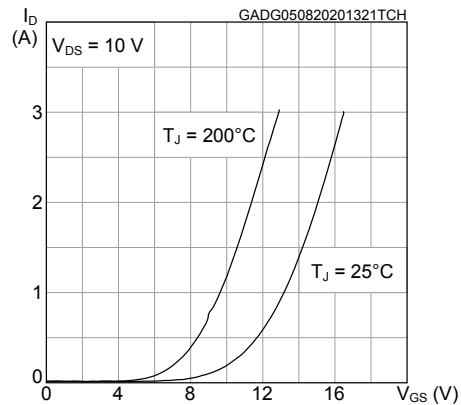


Figure 6. Total power dissipation

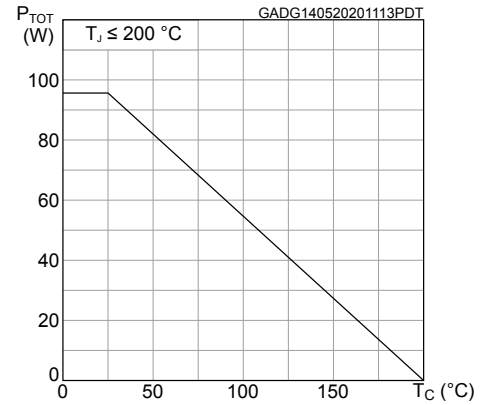


Figure 7. Typical gate charge characteristics

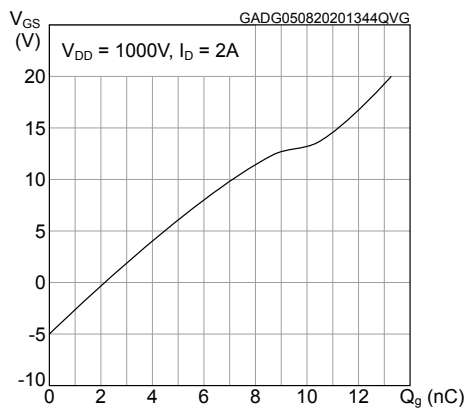


Figure 8. Typical capacitance characteristics

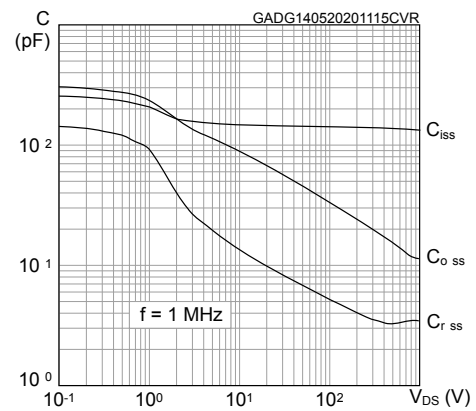


Figure 9. Typical switching energy vs I_D

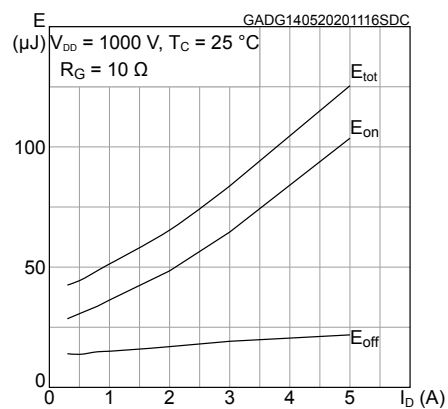


Figure 10. Typical switching energy vs temperature

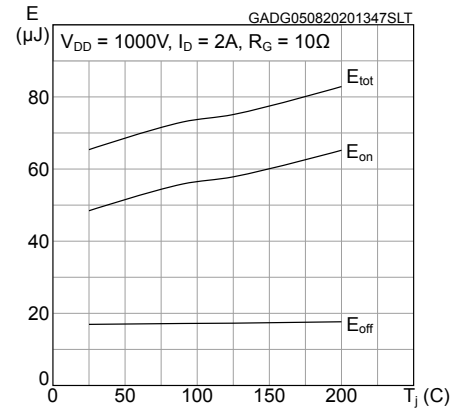


Figure 11. Typical switching energy vs R_G

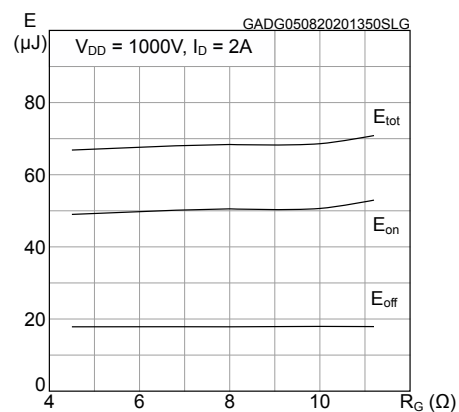


Figure 12. Typical drain-source on-resistance

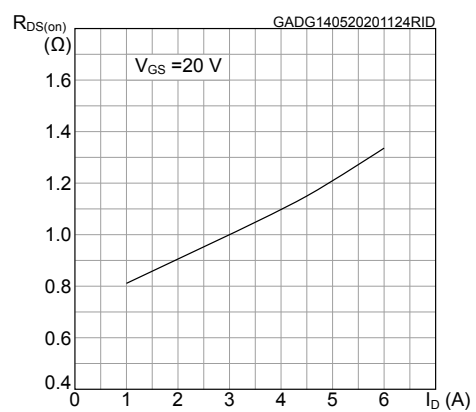


Figure 13. Normalized breakdown voltage vs temperature

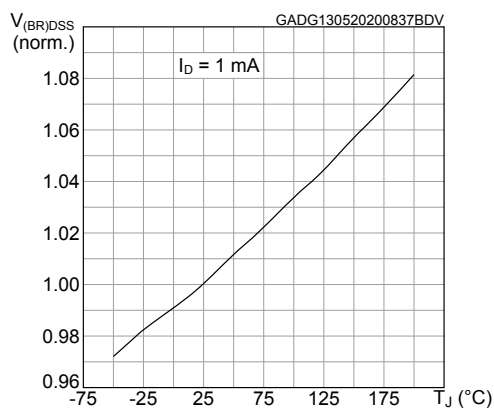


Figure 14. Normalized gate threshold vs temperature

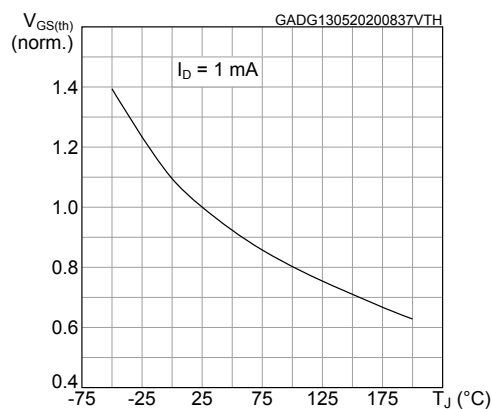


Figure 15. Normalized on-resistance vs temperature

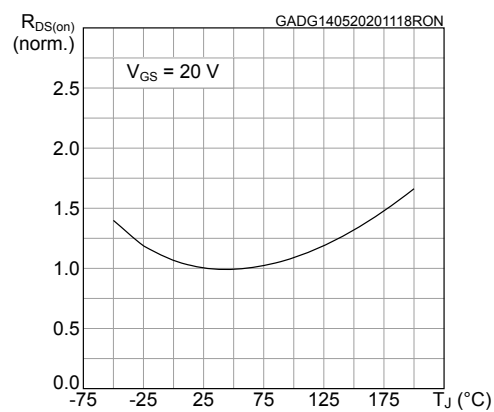


Figure 16. Typical reverse conduction characteristics (T_J = 25 °C)

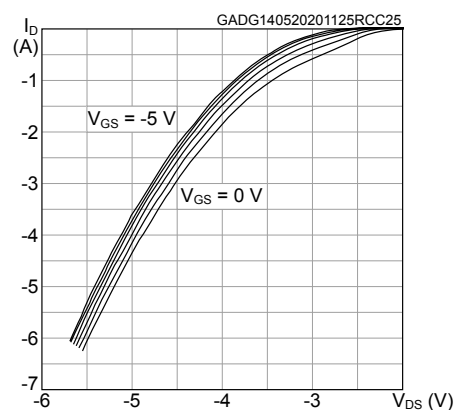
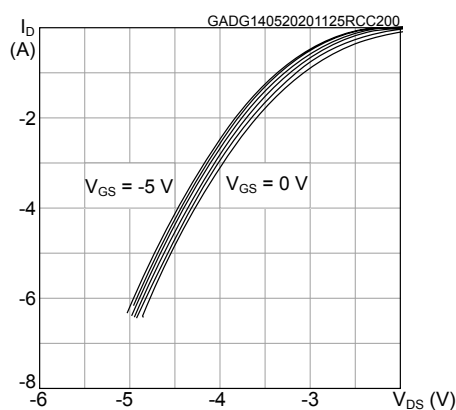


Figure 17. Typical reverse conduction characteristics (T_J = 200 °C)

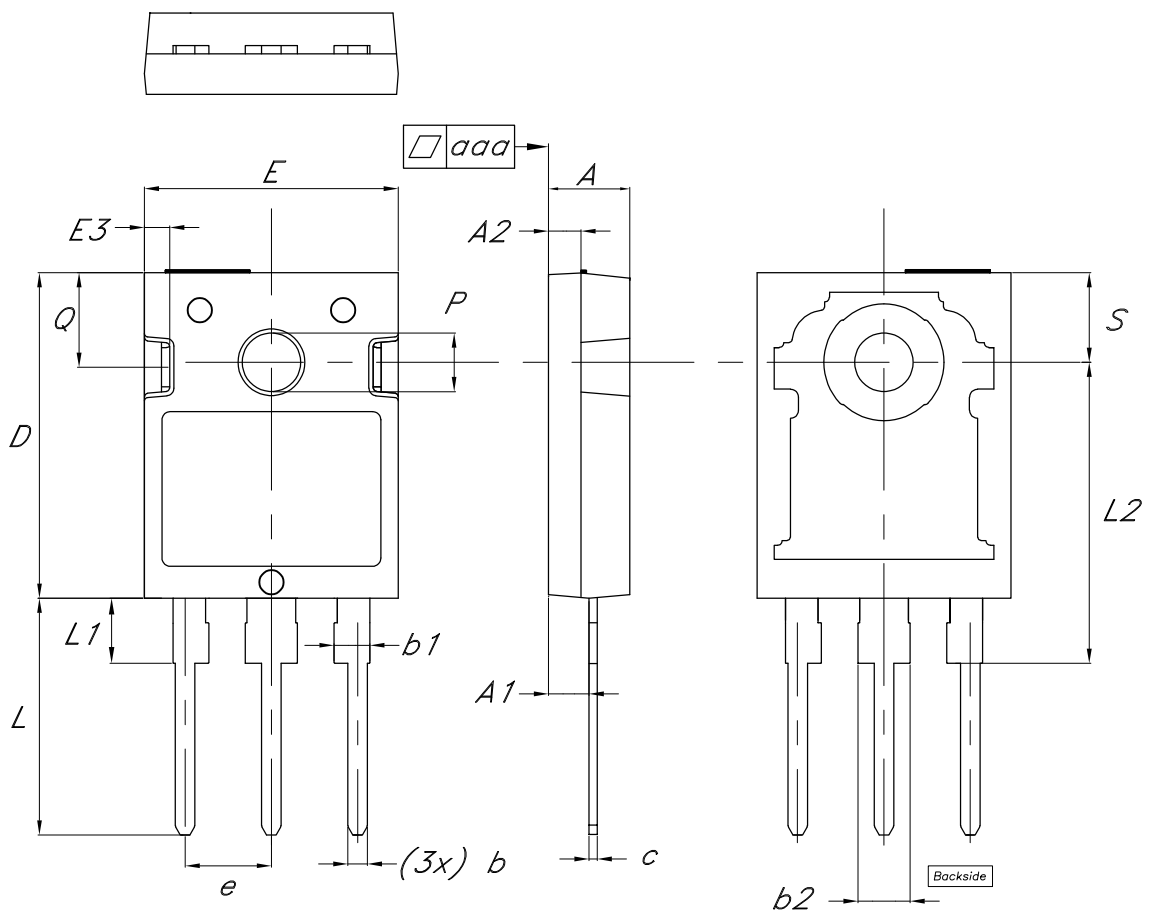


3 Package information

In order to meet environmental requirements, ST offers these devices in different grades of **ECOPACK** packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

3.1 HiP247 package information

Figure 18. HiP247 package outline



8581091_4

Table 7. HiP247 package mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.85	5.00	5.15
A1	2.20		2.60
A2	1.90	2.00	2.10
b	1.00		1.40
b1	2.00		2.40
b2	3.00		3.40
c	0.40		0.80
D	19.85	20.00	20.15
E	15.45	15.60	15.75
E3	1.45		1.65
e	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2	18.30	18.50	18.70
P	3.55		3.65
Q	5.65		5.95
S	5.30	5.50	5.70
aaa		0.04	0.10

Revision history

Table 8. Document revision history

Date	Revision	Changes
29-Jul-2015	1	First release.
10-Feb-2017	2	Updated title and features on cover page. Updated <i>Section 1: "Electrical ratings"</i> and <i>Section 2: "Electrical characteristics"</i> . Minor text changes.
04-Aug-2020	3	Updated <i>Section 1 Electrical ratings</i> . Updated <i>Section 2 Electrical characteristics</i> . Updated <i>Section 2.1 Electrical characteristics (curves)</i> . Updated <i>Section 3.1 HiP247 package</i> . Minor text changes.
26-Apr-2021	4	Updated title and <i>Features</i> in cover page. Updated <i>Table 2. Thermal data</i> . Updated <i>Table 3. On/off states</i> . Updated <i>Section 3 Package information</i> .
30-Apr-2021	5	Updated <i>Features</i> in cover page. Updated <i>Table 1. Absolute maximum ratings</i> . Updated <i>Table 3. On/off states</i> .

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